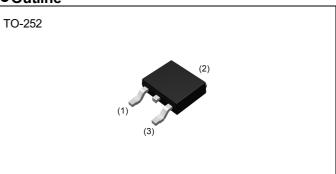
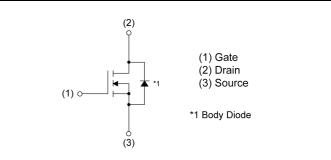


V _{DSS}	600V
R _{DS(on)} (Max.)	0.39Ω
I _D	±11A
P _D	124W

● Outline



Inner circuit



Application

Switching

Features

1) Low on-resistance

3) Parallel use is easy

2) Ultra fast switching speed

4) Pb-free plating ; RoHS compliant

Packaging specifications

Packing	Embossed Tape
Packing code	TL1
Marking	R6011K
Basic ordering unit (pcs)	2500

• Absolute maximum ratings (T_a = 25°C ,unless otherwise specified)

Parameter		Symbol	Value	Unit
Drain - Source voltage		V _{DSS}	600	V
Continuous drain current (T _c = 2	5°C)	۱ _D *1	±11	А
Pulsed drain current		1 _{DP} *2	±33	А
static			±20	V
Gate - Source voltage	AC(f>1Hz)	V _{GSS}	±30	V
Avalanche current, single pulse		I _{AS}	1.8	А
Avalanche energy, single pulse		E _{AS} *3	210	mJ
Power dissipation ($T_c = 25^{\circ}C$)		P _D	124	W
Junction temperature		Τ _j	150	°C
Operating junction and storage temperature range		T _{stg}	-55 to +150	°C

•Thermal resistance

Deremeter	Cumph of	Values			Lincit
Parameter	Symbol	Min.	Тур.	Max.	Unit
Thermal resistance, junction - case	R_{thJC}^{*4}	-	-	1.0	°C/W
Thermal resistance, junction - ambient	R_{thJA}^{*5}	-	-	147	°C/W
Soldering temperature, wavesoldering for 10s	T _{sold}	-	-	265	°C

•Electrical characteristics (T_a = 25°C)

Parameter	Sumbol	Conditions	Values			Unit
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Drain - Source breakdown voltage	$V_{(BR)DSS}$ $V_{GS} = 0V, I_D = 1mA$		600	-	-	V
		V _{DS} = 600V, V _{GS} = 0V				
Zero gate voltage drain current	I _{DSS}	$T_j = 25^{\circ}C$	-	-	100	μA
		T _j = 125°C	-	-	1000	
Gate - Source leakage current	I _{GSS}	V_{GS} = ±20V, V_{DS} = 0V	-	-	±100	nA
Gate threshold voltage	V _{GS(th)}	V _{DS} = 10V, I _D = 1mA	3	-	5	V
		V _{GS} = 10V, I _D = 3.8A				
Static drain - source on - state resistance	R _{DS(on)} *6	$T_j = 25^{\circ}C$	-	0.34	0.39	Ω
		$T_j = 125^{\circ}C$	-	0.72	-	
Gate resistance	R _G	f = 1MHz, open drain	-	1.5	-	Ω



• Electrical characteristics (T_a = 25°C)

Deremeter	C: make al	Conditions	Values			l linit
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Forward Transfer Admittance	$ Y_{fs} ^{*6}$ $V_{DS} = 10V, I_D = 5.5A$		2.9	5.8	-	S
Input capacitance	C _{iss}	V _{GS} = 0V	-	740	-	
Output capacitance	C _{oss}	V _{DS} = 25V	-	630	-	pF
Reverse transfer capacitance	C _{rss}	f = 1MHz	-	30	-	
Turn - on delay time	t _{d(on)} *6	$V_{DD} \simeq 300$ V, V_{GS} = 10V	-	20	-	
Rise time	t,*6	I _D = 5.5A	-	25	-	
Turn - off delay time	t _{d(off)} *6	R _L ≃ 54.9Ω	-	40	-	ns
Fall time	t _f *6	R _G = 10Ω	-	20	-	

• Gate charge characteristics ($T_a = 25^{\circ}C$)

Deremeter	Queen al	Conditions	Values			L La H
Parameter	Symbol	mbol Conditions		Тур.	Max.	Unit
Total gate charge	Q_{g}^{*6}	V _{DD} ≃ 300V	-	22	-	
Gate - Source charge	Q _{gs} *6	I _D = 11A	-	6	-	nC
Gate - Drain charge	Q _{gd} *6	V _{GS} = 10V	-	10	-	
Gate plateau voltage	V _(plateau)	$V_{DD} \simeq 300V$, $I_D = 11A$	-	6.7	-	V

*1 Limited only by maximum channel temperature allowed.

- *2 Pw \leq 10µs, Duty cycle \leq 1%
- *3 L \doteqdot 100mH, V_{DD}=50V, R_G=25 Ω , STARTING T_i=25°C
- *4 T_C=25°C
- *5 Mounted on a epoxy PCB FR4 (25mm x 27mm x 0.8mm)
- *6 Pulsed



•Body diode electrical characteristics (Source-Drain) (T_a = 25°C)

Parameter	Symbol	Conditions	Values			Unit
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Source current	۱ _S *1	$T = 25^{\circ}$	-	-	11	А
Pulsed source current	I_{SP}^{*2}	T _C = 25°C	-	-	33	А
Source-Drain voltage	V_{SD}^{*6}	V _{GS} = 0V, I _S = 11A	-	-	1.5	V
Reverse recovery time	t _{rr} *6		-	355	-	ns
Reverse recovery charge	Q _{rr} *6	I _S = 11A di/dt = 100A/µs	-	3.8	-	μC
Peak reverse recovery current	۲ _۳ *6		-	22	-	А





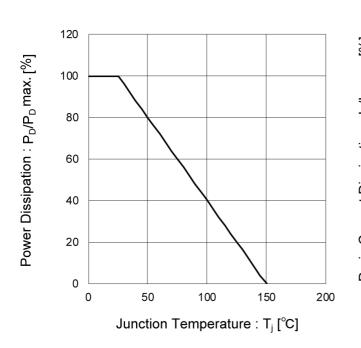


Fig.1 Power Dissipation Derating Curve

Fig.2 Drain Current Derating Curve vs. Junction Temperature

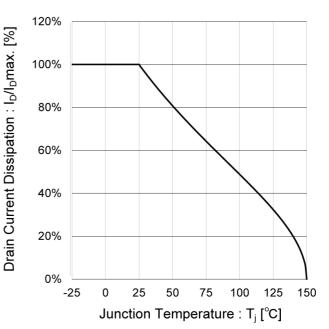


Fig.3 Normalized Transient Thermal Resistance vs. Pulse Width

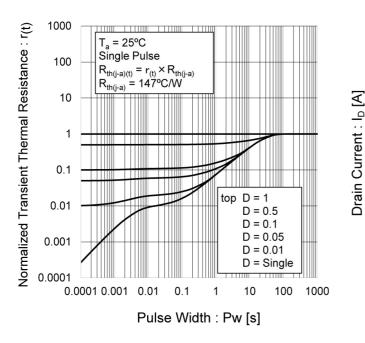
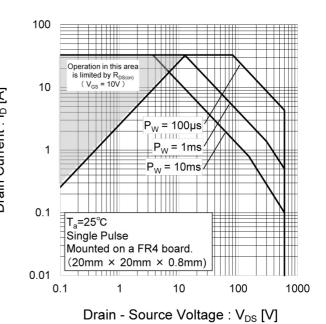


Fig.4 Maximum Safe Operating Area





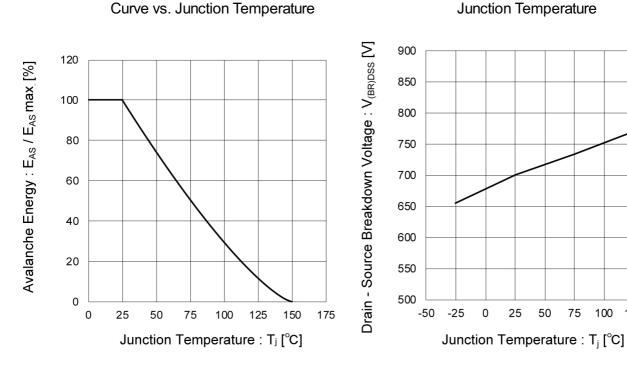


Fig.5 Avalanche Energy Derating Curve vs. Junction Temperature

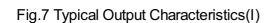
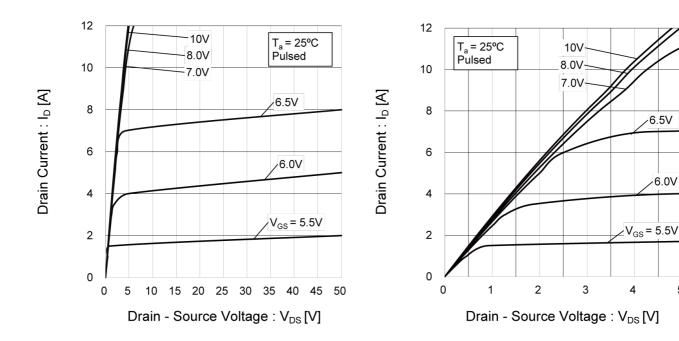


Fig.8 Typical Output Characteristics(II)

75

100 125 150

Fig.6 Breakdown Voltage vs.





5

Fig.9 Typical Transfer Characteristics

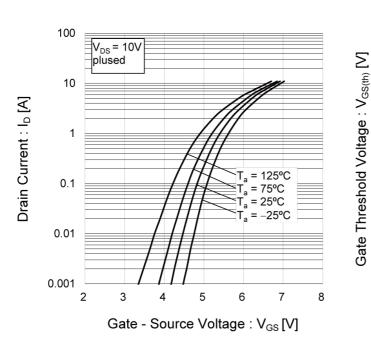


Fig.10 Gate Threshold Voltage vs. Junction Temperature

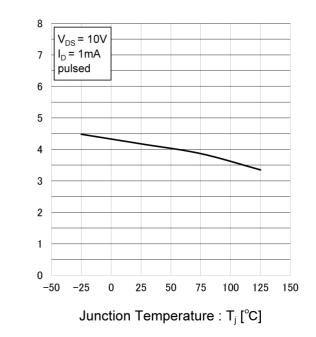
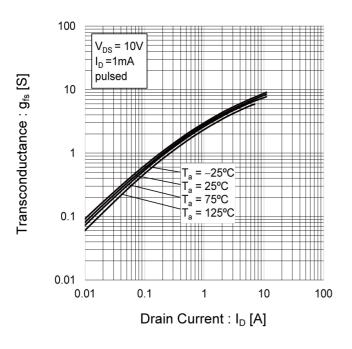


Fig.11 Forward Transfer Admittance vs. Drain Current





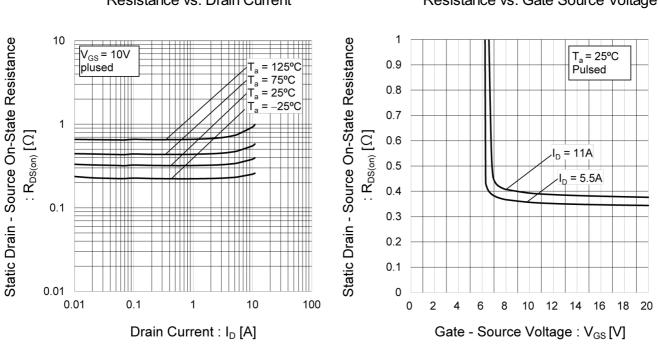
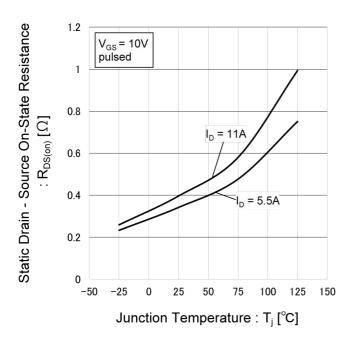


Fig.12 Static Drain - Source On - State Resistance vs. Drain Current Fig.13 Static Drain - Source On - State Resistance vs. Gate Source Voltage

Fig.14 Static Drain - Source On - State Resistance vs. Junction Temperature







= 25°C V_{DD}= 300V V_{GS}= 10V

 $R_{G} = 10\Omega$

10

Pulsed

1

• Electrical characteristic curves

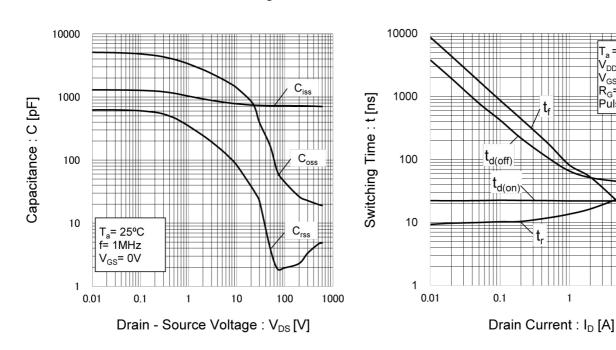
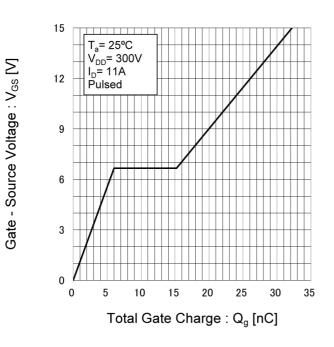


Fig.15 Typical Capacitance vs. Drain - Source Voltage

Fig.16 Switching Characteristics

Fig.17 Typical Gate Charge





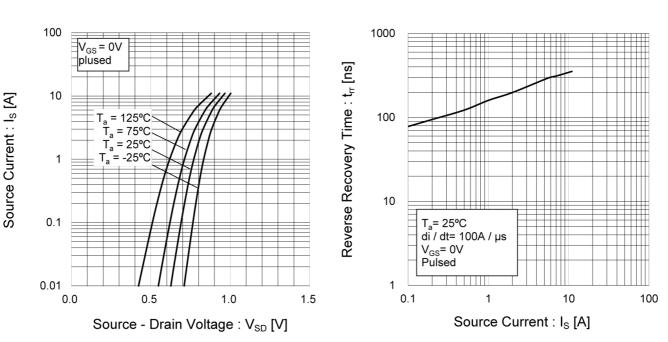


Fig.18 Source Current vs. Source - Drain Voltage Fig.19 Reverse Recovery Time vs. Source Current



Measurement circuits

Fig.1-1 Switching Time Measurement Circuit

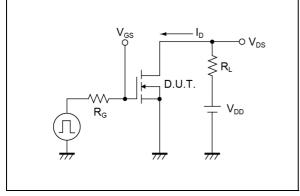


Fig.2-1 Gate Charge Measurement Circuit

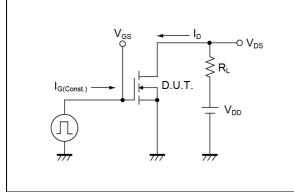


Fig.3-1 Avalanche Measurement Circuit

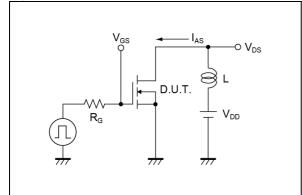


Fig.4-1 trr Measurement Circuit

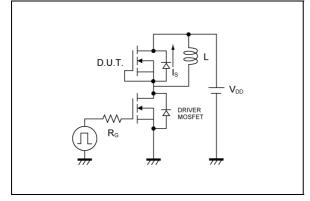


Fig.1-2 Switching Waveforms

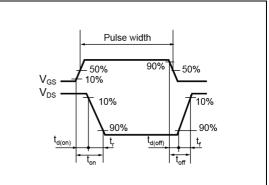


Fig.2-2 Gate Charge Waveform

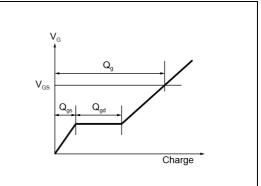


Fig.3-2 Avalanche Waveform

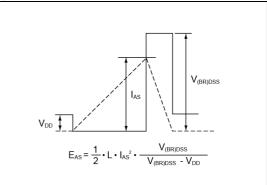
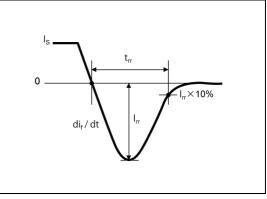
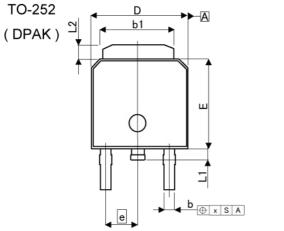


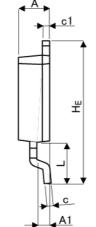
Fig.4-2 trr Waveform

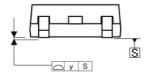


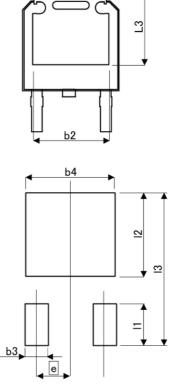


Dimensions









Pattern of terminal position areas [Not a recommended pattern of soldering pads]

DIM	MILIME	ETERS	INC	HES
DIM	MIN	MAX	MIN	MAX
A	2.20	2.40	0.087	0.094
A1	0.70	1.10	0.028	0.043
b	0.60	0.90	0.024	0.035
b1	5.20	5.50	0.205	0.217
b2	4.	80	0.1	189
С	0.40	0.60	0.016	0.024
c1	0.40	0.60	0.016	0.024
D	6.40	6.80	0.252	0.268
е	2.	2.30)91
E	6.00	6.40	0.236	0.252
HE	9.40	10.40	0.370	0.409
L	2.	90	0.1	114
L1	0.60	1.00	0.024	0.039
L2	0.70	1.30	0.028	0.051
L3	5.	30	0.2	209
x	-	0.25	-	0.010
у	-	0.10	-	0.004
DIM	MILIME	ETERS	INC	HES
DIM	MIN	MAX	MIN	MAX
b3	-	1.15	- 1	0.045
b4	-	5.55		0.219
1	-	2.77	-	0.109
12	-	5.50		0.217
13	-	10.40	141	0.409

Dimension in mm/inches



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CLASSⅣ	CLASSIII	CLASSⅢ	CLASSI

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 - [b] Use of our Products outdoors or in places where the Products are exposed to direct sunlight or dust
 - [c] Use of our Products in places where the Products are exposed to sea wind or corrosive gases, including Cl₂, H₂S, NH₃, SO₂, and NO₂
 - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
 - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
 - [f] Sealing or coating our Products with resin or other coating materials
 - [g] Use of our Products without cleaning residue of flux (even if you use no-clean type fluxes, cleaning residue of flux is recommended); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
 - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse. is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
- 9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

Precaution for Mounting / Circuit board design

- 1. When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- 2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

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- 1. If change is made to the constant of an external circuit, please allow a sufficient margin considering variations of the characteristics of the Products and external components, including transient characteristics, as well as static characteristics.
- 2. You agree that application notes, reference designs, and associated data and information contained in this document are presented only as guidance for Products use. Therefore, in case you use such information, you are solely responsible for it and you must exercise your own independent verification and judgment in the use of such information contained in this document. ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties arising from the use of such information.

Precaution for Electrostatic

This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

Precaution for Storage / Transportation

- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
 - [a] the Products are exposed to sea winds or corrosive gases, including Cl2, H2S, NH3, SO2, and NO2
 - [b] the temperature or humidity exceeds those recommended by ROHM
 - [c] the Products are exposed to direct sunshine or condensation
 - [d] the Products are exposed to high Electrostatic
- 2. Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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A two-dimensional barcode printed on ROHM Products label is for ROHM's internal use only.

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R6011KND3 - Web Page

Part Number	R6011KND3
Package	TO-252
Unit Quantity	2500
Minimum Package Quantity	2500
Packing Type	Taping
Constitution Materials List	inquiry
RoHS	Yes